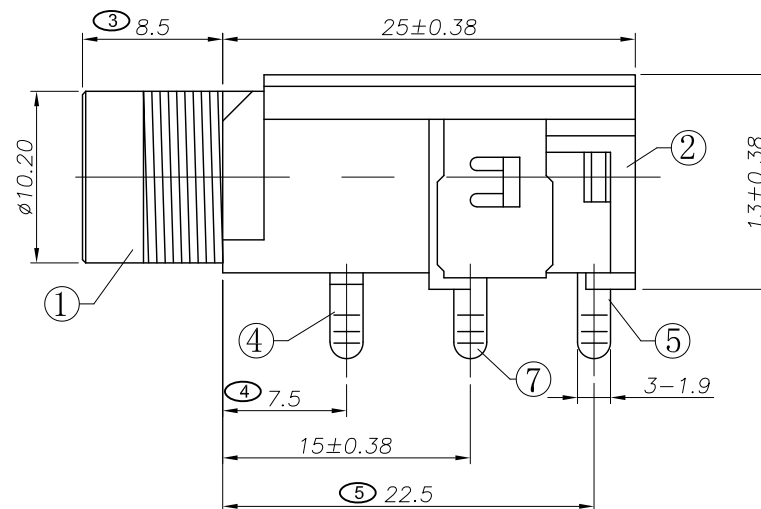
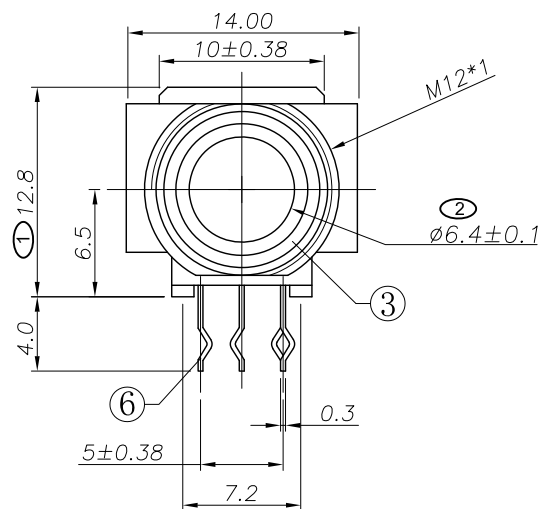
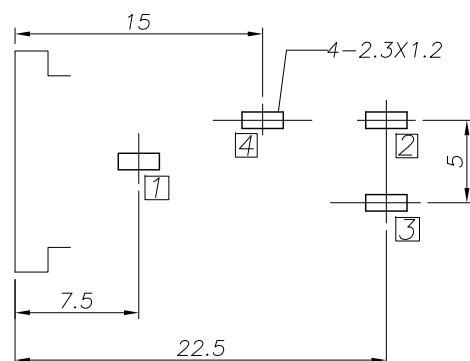




SPECIFICATION

1. Rating : DC 30V 1A;
2. Contact resistance: $\leq 30\text{m}\Omega$;
3. Insulation resistance: $\geq 100\text{M}\Omega$;
4. Withstand voltage: 500VAC ;
5. Insertion and extraction force: 3-30N;
6. life test: 5,000 cycles.

※ SIGN “(X)” IS IMPORTANCE DIMENSION



P. C. B Layout

(Copper-sided view)

Model NO.	KPJD-603-6.35-X
Schematic	

⑦	SHUNT	④		Mn65	Sn-Plating
⑥	RING	③		Mn65	Sn-Plating
⑤	TIP	②		Mn65	Sn-Plating
④	EARTHING	①		Mn65	Sn-Plating
③	BUSHING	1		Copper alloy	X:N=Ni-Plating - =Au-Plating
②	COVER	1		ABS	Black
①	HOUSING	1		ABS	Black
NO.	DESCRIPTION	QTY		MATERIAL	PLATING

KEM 奇速科技有限公司
Qi-Speed Technology CO., LTD.

產品名稱:
PRODUCT NAME
PHONE JACK

單位 : mm	繪圖	設計	審核	核准	料號:KPJD-603-6.35-X
比例 :	DRAWING	DESIGNED	CHECKED BY	APPROVAL BY	PART NUMBER
公差 : .X ±0.38 .XX ±0.25 .XXX ±0.13	JOHNY	JOHNY	LUKE	JAMES	圖號:KPJD-603-6.35-X-1 DRAWING NO
日期 : 2021/4/30					版本: REV. 0

版本	修改事項	修改日期